## Features

- 18 Mbps (max.) data rate when driven by a totem pole driver
■ 6.8 Mbps (max.) data rate when driven by an open drain pole driver
- Bidirectional level translation, without direction pin
■ Wide $\mathrm{V}_{\mathrm{L}}$ voltage range of 1.65 V to 3.6 V
■ Wide $\mathrm{V}_{\mathrm{CC}}$ voltage range of 1.80 V to 5.5 V
- Integrated $10 \mathrm{k} \Omega$ pull-up on both $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{L}}$ sides
- Power-down mode feature; when either supply is off, all I/Os are in high impedance
■ Low quiescent current (max. $4 \mu \mathrm{~A}$ )
- Able to be driven by totem pole and open drain drivers
- 5.5 V tolerant enable pin

■ ESD performance on all pins: $\pm 2 \mathrm{kV}$ HBM

- Small package and footprint - QFN10 (1.8 x 1.4 mm ) package


## Applications

- Low voltage system level translation
- Mobile phones and other mobile devices
- $I^{2} C$ level translation
- UART level translation


Table 1. Device summary

| Order code | Package | Packing |
| :---: | :---: | :---: |
| ST2329IQTR | QFN10 | Tape and reel |
|  | $(1.8 \times 1.4 \mathrm{~mm})$ | $(3000$ parts per reel $)$ |

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## 1 <br> Description

ST23291 is a 2-bit dual-supply level translator which provides the level shifting capability to allow data transfer in a multi-voltage system. Externally applied voltages, $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{L}}$, set the logic levels on either side of the device. It utilizes a transmission gate based design that allows bidirectional level translation without a control pin.

The ST2329I accepts $\mathrm{V}_{\mathrm{L}}$ from 1.65 V to 3.6 V and $\mathrm{V}_{\mathrm{CC}}$ from 1.80 V to 5.5 V , making it ideal for data transfer between low-voltage ASICs/PLD and higher voltage systems. This device has a tri-state output mode which can be used to disable all the I/Os.
The ST23291 supports power-down mode when $\mathrm{V}_{\mathrm{CC}}$ is grounded/floating and the device is disabled via the OE pin. The device has integrated $10 \mathrm{k} \Omega$ pull-ups on both sides.

## 2 Pin configuration

Figure 1. Pin configuration


Table 2. Pin description

| QFN10 pin no | Symbol | Name and function |
| :---: | :---: | :---: |
| 1,2 | $\mathrm{I}^{\prime} \mathrm{O}_{\mathrm{VL} 1}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VL} 2}$ | Data inputs/outputs |
| 8,7 | $\mathrm{I}_{\mathrm{VCC} 1}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC} 2}$ | Data inputs/outputs |
| 3 | OE | Output enable input |
| 6 | GND | Ground |
| 10 | $\mathrm{~V}_{\mathrm{L}}$ | Supply voltage |
| 9 | $\mathrm{~V}_{\mathrm{CC}}$ | Supply voltage |
| 4,5 | NC | No connect |

Figure 2. Device block diagram


1. ST2329I has 2 channels. For simplicity, the diagram above shows only 1 channel.
2. When OE is LOW, all I/Os are in high impedance mode.

Figure 3. Typical application diagram


1. External pull-up resistors are optional. Only needed if a pull-up value lower than $10 \mathrm{k} \Omega$ is desired.

### 2.1 Supplementary notes

### 2.1.1 Driver requirements

The ST2329I may be driven by an open drain or totem pole driver and the nature of the device output is "open drain". It must not be used to drive a pull-down resistor as the impedance of the output at HIGH state depends on the pull-up resistor placed at the I/Os.

As the device has pull-up resistors on both $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}$ and $\mathrm{I} / \mathrm{O}_{\mathrm{VL}}$ ports, the user needs to ensure that the driver is able to sink the required amount of current. For example, if the settings are $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=4.3 \mathrm{~V}$, and the pull-up resistor is $10 \mathrm{k} \Omega$ then the driver must be able to sink at least $(5.5 \mathrm{~V} / 10 \mathrm{k} \Omega)+(4.3 \mathrm{~V} / 10 \mathrm{k} \Omega) \approx 1 \mathrm{~mA}$ and still meet $\mathrm{V}_{\mathrm{IL}}$ requirements of ST2329I.

### 2.1.2 Load driving capability

To support the open drain system, the one-shot transistor is turned on only during high transition at the output side. When it drives a high state, after the one-shot transistor turned off, only the pull-up resistor is able to maintain the state. In this case, the resistive load is not recommended.

### 2.1.3 Power-off feature

In some applications where it might be required to turn off one of the power supplies powering up the level translator, the user may turn OFF the $\mathrm{V}_{\mathrm{CC}}$ only when the OE pin is low (device is disabled). There is no current consumption in $\mathrm{V}_{\mathrm{L}}$ due to floating gates or other causes, and the I/Os are in a high impedance state in this mode.

Table 3. Truth table

| Enable | Bidirectional input/output |  |
| :---: | :---: | :---: |
| OE | $\mathrm{I} \mathrm{O}_{\mathrm{VCC}}$ | $\mathrm{I} / \mathrm{O}_{\mathrm{VL}}$ |
| $\mathrm{H}^{(1)}$ | $\mathrm{H}^{(2)}$ | $\mathrm{H}^{(1)}$ |
| $\mathrm{H}^{(1)}$ | L | L |
| L | $\mathrm{Z}^{(3)}$ | Z |

1. High level $\mathrm{V}_{\mathrm{L}}$ power supply referred.
2. High level $\mathrm{V}_{\mathrm{CC}}$ power supply referred.
3. $Z=$ high impedance.

Table 4. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{L}}$ | Supply voltage | -0.3 to 4.6 | V |
| $\mathrm{~V}_{\mathrm{CC}}$ | Supply voltage | -0.3 to 6.5 | V |
| $\mathrm{~V}_{\mathrm{OE}}$ | DC control input voltage | -0.3 to 6.5 | V |
| $\mathrm{~V}_{\mathrm{I} / \mathrm{OVL}}$ | $\mathrm{DC} \mathrm{I/O} \mathrm{VL}_{\mathrm{VL}}$ input voltage (OE = GND or $\mathrm{V}_{\mathrm{L}}$ ) | -0.3 to $\mathrm{V}_{\mathrm{L}}+0.3$ | V |
| $\mathrm{~V}_{\mathrm{I} / \mathrm{OVCC}}$ | $\mathrm{DC} \mathrm{I/O} \mathrm{VCC}$ input voltage (OE = GND or $\mathrm{V}_{\mathrm{L}}$ ) | -0.3 to $\mathrm{V}_{\mathrm{CC}}+0.3$ | V |
| $\mathrm{I}_{\mathrm{IK}}$ | DC input diode current | -20 | mA |
| $\mathrm{I}_{\mathrm{I} / \mathrm{OVL}}$ | DC output current | $\pm 25$ | mA |
| $\mathrm{I}_{\mathrm{I} / \mathrm{OVCC}}$ | DC output current | $\pm 258$ | mA |
| $\mathrm{I}_{\mathrm{SCTOUT}}$ | Short-circuit duration, continuous | 40 | mA |
| $\mathrm{P}_{\mathrm{D}}$ | Power dissipation ${ }^{(1)}$ | 500 | mW |
| $\mathrm{~T}_{\mathrm{STG}}$ | Storage temperature | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |
| TL | Lead temperature (10 seconds) | 300 | ${ }^{\circ} \mathrm{C}$ |
| ESD | Electrostatic discharge protection (HBM) | $\pm 2$ | KV |

1. $500 \mathrm{~mW}: 65^{\circ} \mathrm{C}$ derated to 300 mW by $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}: 65^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

Table 5. Recommended operating conditions

| Symbol | Parameter | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{L}}$ | Supply voltage | 1.65 |  | 3.6 | V |
| $\mathrm{~V}_{\mathrm{CC}}{ }^{(1)}$ | Supply voltage | 1.8 |  | 5.5 | V |
| $\mathrm{~V}_{\mathrm{OE}}$ | Input voltage (OE output enable pin, $\mathrm{V}_{\mathrm{L}}$ power <br> supply referred) | 0 |  | 3.6 | V |
| $\mathrm{~V}_{\mathrm{I} / \mathrm{OVL}}$ | I/O $\mathrm{VL}_{\mathrm{VL}}$ voltage | 0 |  | $\mathrm{~V}_{\mathrm{L}}$ | V |
| $\mathrm{V}_{\mathrm{I} / \mathrm{OVCC}}$ | $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}$ voltage | 0 |  | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| TOP | Operating temperature | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{dt/dV}$ | Input rise and fall time | 0 |  | 1 | $\mathrm{~ns} / \mathrm{V}$ |

1. $V_{C C}$ must be greater than $V_{L}$.

Table 6. DC characteristics (over recommended operating conditions unless otherwise noted. All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| Symbol | Parameter | Test conditions |  |  | Value |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathbf{L}}$ | $\mathrm{V}_{\mathrm{CC}}$ |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | -40 to $85^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  |  | Min. | Typ. | Max. | Min. | Max. |  |
| $\mathrm{V}_{\mathrm{IHL}}$ | High level input voltage on $\mathrm{V}_{\mathrm{L}}$ side $\left(1 / O_{V L}\right)$ | 1.65 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | - | 1.4 |  |  | 1.4 |  | V |
|  |  | 2.0 |  |  | 1.6 |  |  | 1.6 |  |  |
|  |  | 2.5 |  |  | 2.0 |  |  | 2.0 |  |  |
|  |  | 3.0 |  |  | 2.4 |  |  | 2.4 |  |  |
|  |  | 3.6 |  |  | 2.8 |  |  | 2.8 |  |  |
| $\mathrm{V}_{\text {ILL }}$ | Low level input voltage on $\mathrm{V}_{\mathrm{L}}$ side $\left(1 / O_{V L}\right)$ | 1.65 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | - |  |  | 0.3 |  | 0.3 | V |
|  |  | 2.0 |  |  |  |  | 0.4 |  | 0.4 |  |
|  |  | 2.5 |  |  |  |  | 0.5 |  | 0.5 |  |
|  |  | 3.0 |  |  |  |  | 0.6 |  | 0.6 |  |
|  |  | 3.6 |  |  |  |  | 0.8 |  | 0.8 |  |
| $\mathrm{V}_{\mathrm{IHC}}$ | High level input voltage on $\mathrm{V}_{\mathrm{CC}}$ side ( $1 / O_{\mathrm{Vcc}}$ ) | $\begin{gathered} 1.65 \text { to } \\ V_{C C} \end{gathered}$ | 1.65 | - |  | 1.4 |  | 1.6 |  | V |
|  |  |  | 2.0 |  |  | 1.6 |  | 2.3 |  |  |
|  |  |  | 2.5 |  |  | 2.3 |  | 2.7 |  |  |
|  |  |  | 3.0 |  |  | 2.7 |  | 3.3 |  |  |
|  |  |  | 3.6 |  |  | 3.3 |  | 3.5 |  |  |
|  |  |  | 5.5 |  |  | 4.2 |  | 4.2 |  |  |
| $\mathrm{V}_{\text {ILC }}$ | Low level input voltage on $\mathrm{V}_{\mathrm{CC}}$ side ( $1 / \mathrm{O}_{\mathrm{VCc}}$ ) | $\begin{aligned} & 1.65 \text { to } \\ & V_{C C} \end{aligned}$ | 1.65 | - |  |  | 0.3 |  |  | V |
|  |  |  | 2.0 |  |  |  | 0.3 |  |  |  |
|  |  |  | 2.5 |  |  |  | 0.3 |  |  |  |
|  |  |  | 3.0 |  |  |  | 0.5 |  |  |  |
|  |  |  | 3.6 |  |  |  | 0.5 |  |  |  |
|  |  |  | 5.5 |  |  |  | 0.5 |  |  |  |
| $\mathrm{V}_{\mathrm{IH}-\mathrm{OE}}$ | High level input voltage (OE) | 1.65 | $V_{L} \text { to } 5.5$ | - | 1.0 |  |  | 1.0 |  | V |
|  |  | 2.0 |  |  | 1.2 |  |  | 1.2 |  |  |
|  |  | 2.5 |  |  | 1.4 |  |  | 1.4 |  |  |
|  |  | 3.0 |  |  | 1.6 |  |  | 1.6 |  |  |
|  |  | 3.6 |  |  | 2.0 |  |  | 2.0 |  |  |

Table 6. DC characteristics (over recommended operating conditions unless otherwise noted. All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ ) (continued)

| Symbol | Parameter | Test conditions |  |  | Value |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathrm{L}}$ | $\mathrm{V}_{\mathrm{cc}}$ |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | -40 to $85{ }^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  |  | Min. | Typ. | Max. | Min. | Max. |  |
| $\mathrm{V}_{\text {IL-OE }}$ | Low level input voltage (OE) | 1.65 | $V_{L}$ to 5.5 | - |  |  | 0.33 |  | 0.33 | V |
|  |  | 2.0 |  |  |  |  | 0.40 |  | 0.40 |  |
|  |  | 2.5 |  |  |  |  | 0.50 |  | 0.50 |  |
|  |  | 3.0 |  |  |  |  | 0.60 |  | 0.60 |  |
|  |  | 3.6 |  |  |  |  | 0.75 |  | 0.75 |  |
| $\mathrm{V}_{\text {OLL }}$ | Low level output voltage (I/O VL ) | 1.65 to 3.6 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | $\begin{gathered} \mathrm{IO}=1.0 \mathrm{~mA} \\ \mathrm{I} / \mathrm{O}_{\mathrm{Vcc}} \leq 0.15 \mathrm{~V} \end{gathered}$ |  |  | 0.40 |  | 0.40 | V |
| $\mathrm{V}_{\text {OLC }}$ | Low level output voltage ( $/ / \mathrm{O}_{\mathrm{VCC}}$ ) | 1.65 to 3.6 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | $\begin{gathered} \mathrm{IO}=1.0 \mathrm{~mA} \\ \mathrm{I} / \mathrm{O}_{\mathrm{VL}} \leq 0.15 \mathrm{~V} \end{gathered}$ |  |  | 0.40 |  | 0.40 | V |
| loe | Control input leakage current (OE) | 1.65 to 3.6 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | $\mathrm{V}_{\mathrm{OE}}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{L}}$ |  |  | $\pm 0.1$ |  | $\pm 0.1$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IO_LKG }}$ | High impedance leakage current $\left(1 / O_{V L}, I / O_{V C c}\right)$ | 1.65 to 3.6 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | OE = GND |  |  | $\pm 0.1$ |  | $\pm 0.1$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {QVCC }}$ | Quiescent supply current $\mathrm{V}_{\mathrm{CC}}$ | 1.65 to 3.6 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | Only pull-up resistor connected to I/O |  | 3 | 3.5 |  | 6 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {QVL }}$ | Quiescent supply current $\mathrm{V}_{\mathrm{L}}$ | 1.65 to 3.6 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | Only pull-up resistor connected to I/O |  | 0.01 | 0.1 |  | 1 | $\mu \mathrm{A}$ |
| $\mathrm{I} z-\mathrm{vcc}$ | High impedance quiescent supply current $\mathrm{V}_{\mathrm{CC}}$ | 1.65 to 3.6 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | $\begin{gathered} \hline \text { OE = GND; only } \\ \text { pull-up resistor } \\ \text { connected to I/O } \end{gathered}$ |  | 3 | 3.5 |  | 6 | $\mu \mathrm{A}$ |
| I z -vL | High impedance quiescent supply current $\mathrm{V}_{\mathrm{L}}$ | 1.65 to 3.6 | $\mathrm{V}_{\mathrm{L}}$ to 5.5 | $\begin{aligned} & \text { OE = GND; only } \\ & \text { pull-up resistor } \\ & \text { connected to I/O } \end{aligned}$ |  | 0.01 | 0.1 |  | 1 | $\mu \mathrm{A}$ |

### 2.2 AC characteristics (device driven by open drain driver)

Table 7. For test conditions: $\mathrm{V}_{\mathrm{L}}=1.65$ to 1.8 V (load $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} ; \mathrm{R}_{\text {up }}=4.7 \mathrm{k} \Omega$; driver $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}} \leq \mathbf{2 n s}$ ) overtemperature range $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

| Symbol | Parameter |  | $\mathrm{V}_{\mathrm{CC}}=1.8$-2.5 V |  | $\mathrm{V}_{\text {cc }}=2.7-3.6 \mathrm{~V}$ |  | $\mathrm{V}_{\text {cc }}=4.3-5.5 \mathrm{~V}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Min. | Max. | Min. | Max. |  |
| $\mathrm{t}_{\text {RVCC }}$ | Rise time I/O Vcc |  |  | 80 |  | 60 |  | 45 | ns |
| $\mathrm{t}_{\text {FVCC }}$ | Fall time I/O Occ |  |  | 23.2 |  | 33.9 |  | 53.3 | ns |
| $\mathrm{t}_{\mathrm{RVL}}$ | Rise time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}}$ |  |  | 60 |  | 45 |  | 35 | ns |
| $\mathrm{t}_{\mathrm{FVL}}$ | Fall time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}}$ |  |  | 16.4 |  | 17.6 |  | 16.9 | ns |
| $\mathrm{t}_{1 / \mathrm{OVL}-\mathrm{VCC}}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}$-LH $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{HL}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}-\mathrm{HL}$ | $\mathrm{t}_{\text {PLH }}$ |  | 3.4 |  | 2 |  |  | ns |
|  |  | $\mathrm{t}_{\text {PLH }}$ |  | 13.9 |  | 19.1 |  | 30.2 | ns |
| $\mathrm{t}_{\text {/OVCC-VL }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}$-LH to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ I/OVCC-HL to I/OVL-HL | $\mathrm{t}_{\text {PLH }}$ |  | 2 |  | 2 |  | 2.6 | ns |
|  |  | $t_{\text {PLH }}$ |  | 8.6 |  | 9 |  | 9.5 | ns |
| $t_{\text {PZL }} t_{\text {PZH }}$ <br> $t_{\text {PLZ }} \mathrm{t}_{\mathrm{PHZ}}$ | Output enable and disable time | En |  | 10 |  | 10 |  | 10 | ns |
|  |  | Dis |  | 40 |  | 40 |  | 40 | ns |
| $\mathrm{D}_{\mathrm{R}}$ | Data rate ${ }^{(1)}$ |  |  | 1.8 |  | 2.2 |  | 3.4 | MHz |

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than $15 \%$ of the input $I / O$ signal period; the input I/O signal is at $50 \%$ duty cycle and the output I/O signal duty cycle deviation is not less than $30 \%$. Note that the $R_{\text {up }}$ of $4.7 \mathrm{k} \Omega$ is an effective $R$ pull-up value. Since the device has an integrated $10 \mathrm{k} \Omega$ pull-up resistor, an effective value of $4.7 \mathrm{k} \Omega$ is obtained by adding an external $8.9 \mathrm{k} \Omega$ pull-up resistor.

Table 8. For test conditions: $\mathrm{V}_{\mathrm{L}}=2.5$ to $2.7 \mathrm{~V}\left(\operatorname{load} \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} ; \mathrm{R}_{\mathrm{up}}=4.7 \mathrm{k} \Omega\right.$; driver $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}} \leq \mathbf{2 n s}$ ) overtemperature range $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

| Symbol | Parameter |  | $\mathrm{V}_{\mathrm{CC}}=2.7-3.6 \mathrm{~V}$ |  | $\mathrm{V}_{\mathrm{CC}}=4.3-5.5 \mathrm{~V}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Min. | Max. |  |
| $\mathrm{t}_{\text {RVCC }}$ | Rise time I/O Vcc |  |  | 70 |  | 50 | ns |
| $\mathrm{t}_{\text {FVCC }}$ | Fall time I/OV ${ }_{\text {Vcc }}$ |  |  | 14.8 |  | 19.1 | ns |
| $\mathrm{t}_{\text {RVL }}$ | Rise time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}}$ |  |  | 50 |  | 35 | ns |
| $\mathrm{t}_{\mathrm{FVL}}$ | Fall time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}}$ |  |  | 9.8 |  | 10 | ns |
| $\mathrm{t}_{\text {//OVL-VCC }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}} \mathrm{LH}$ I/OVL-HL to I/OVCC-HL | $\mathrm{t}_{\text {PLH }}$ |  | 2 |  | 2 | ns |
|  |  | $\mathrm{t}_{\text {PLH }}$ |  | 8.2 |  | 11.6 | ns |
| $\mathrm{t}_{\text {/OVCC-VL }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}-\mathrm{LH}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}-\mathrm{HL}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{HL}}$ | $\mathrm{t}_{\text {PLH }}$ |  | 2 |  | 2 | ns |
|  |  | $\mathrm{t}_{\text {PLH }}$ |  | 5.3 |  | 5.9 | ns |
| $t_{\text {PZL }}{ }^{t_{\text {PZH }}}$ <br> $t_{\text {pLZ }} \mathrm{t}_{\mathrm{PHZ}}$ | Output enable and disable time | En |  | 6 |  | 6 | ns |
|  |  | Dis |  | 40 |  | 40 | ns |
| $\mathrm{D}_{\mathrm{R}}$ | Data rate ${ }^{(1)}$ |  |  | 2.2 |  | 3.0 | MHz |

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than $15 \%$ of the input I/O signal period; the input I/O signal is at $50 \%$ duty cycle and the output I/O signal duty cycle deviation is not less than $30 \%$. Note that the $\mathrm{R}_{\text {up }}$ of $4.7 \mathrm{k} \Omega$ is an effective R pull-up value. Since the device has an integrated $10 \mathrm{k} \Omega$ pull-up resistor, an effective value of $4.7 \mathrm{k} \Omega$ is obtained by adding an external $8.9 \mathrm{k} \Omega$ pull-up resistor.

Table 9. For test conditions: $\mathrm{V}_{\mathrm{L}}=2.7$ to $3.6 \mathrm{~V}\left(\operatorname{load} \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} ; \mathrm{R}_{\mathrm{up}}=4.7 \mathrm{k} \Omega ;\right.$ driver $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}} \leq 2 \mathrm{~ns}$ ) overtemperature range $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

| Symbol | Parameter |  | $\mathrm{V}_{\mathrm{CC}}=4.3-5.5 \mathrm{~V}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. |  |
| $t_{\text {RVCC }}$ | Rise time I/O ${ }_{\mathrm{Vcc}}$ |  |  | 55 | ns |
| $\mathrm{t}_{\text {FVCC }}$ | Fall time I/O VCC |  |  | 17.2 | ns |
| $\mathrm{t}_{\text {RVL }}$ | Rise time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}}$ |  |  | 40 | ns |
| $\mathrm{t}_{\text {FVL }}$ | Fall time $1 / \mathrm{O}_{\mathrm{VL}}$ |  |  | 9.7 | ns |
| $\mathrm{t}_{\text {//OVL-VCC }}$ | Propagation delay time I/OVL-LH to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}-\mathrm{LH}}$ I/OVL-HL to I/OVCC-HL | $\mathrm{t}_{\text {PLH }}$ |  | 2 | ns |
|  |  | $t_{\text {PLH }}$ |  | 10.6 | ns |
| $\mathrm{t}_{\text {/OVCC-VL }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}-\mathrm{LH}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}-\mathrm{HL}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{HL}}$ | $\mathrm{t}_{\mathrm{PLH}}$ |  | 2 | ns |
|  |  | $t_{\text {PLH }}$ |  | 4.8 | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PZL}} \mathrm{t}_{\mathrm{PZH}} \\ & \mathrm{t}_{\mathrm{PLZ}} \mathrm{t}_{\mathrm{PHZ}} \end{aligned}$ | Output enable and disable time | En |  | 6 | ns |
|  |  | Dis |  | 40 | ns |
| DR | Data rate ${ }^{(1)}$ |  |  | 3.0 | MHz |

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than $15 \%$ of the input I/O signal period; the input I/O signal is at $50 \%$ duty cycle and the output I/O signal duty cycle deviation is not less than $30 \%$.
Note that the $R_{\text {up }}$ of $4.7 \mathrm{k} \Omega$ is an effective $R$ pull-up value. Since the device has an integrated $10 \mathrm{k} \Omega$ pull-up resistor, an effective value of $4.7 \mathrm{k} \Omega$ is obtained by adding an external $8.9 \mathrm{k} \Omega$ pull-up resistor.

### 2.3 AC characteristics (device driven by totem pole driver)

Table 10. For test conditions: $\mathrm{V}_{\mathrm{L}}=1.65$ to 1.8 V (load $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} ; \mathrm{R}_{\text {up }}=10 \mathrm{k} \Omega$; driver $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}} \leq \mathbf{2 n s}$ ) overtemperature range $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

| Symbol | Parameter |  | $\mathrm{V}_{\mathrm{CC}}=1.8$-2.5 V |  | $\mathrm{V}_{\mathrm{cc}}=2.7-3.6 \mathrm{~V}$ |  | $\mathrm{V}_{\mathrm{cc}}=4.3-5.5 \mathrm{~V}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Min. | Max. | Min. | Max. |  |
| $\mathrm{t}_{\mathrm{RVCC}}$ | Rise time I/OVcc |  |  | 7.2 |  | 4.6 |  | 1.4 | ns |
| $\mathrm{t}_{\text {FVCC }}$ | Fall time I/O VCc |  |  | 23.2 |  | 33.9 |  | 53.3 | ns |
| $\mathrm{t}_{\mathrm{RVL}}$ | Rise time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}}$ |  |  | 5.9 |  | 5.7 |  | 5.5 | ns |
| $\mathrm{t}_{\mathrm{FVL}}$ | Fall time $/ / \mathrm{O}_{\mathrm{VL}}$ |  |  | 16.4 |  | 17.6 |  | 16.9 | ns |
| $\mathrm{t}_{\text {/OVL-VCC }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}} \mathrm{LH}$ I/OVL-HL to I/OVCC-HL | $\mathrm{t}_{\text {PLH }}$ |  | 5.5 |  | 4.1 |  | 3.6 | ns |
|  |  | $\mathrm{t}_{\text {PLH }}$ |  | 13.9 |  | 19.1 |  | 30.2 | ns |
| $\mathrm{t}_{\text {/ OVCC-VL }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}$-LH to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}-\mathrm{HL}$ to $\mathrm{I} / \mathrm{OVL}_{\mathrm{VL}} \mathrm{HL}$ | $\mathrm{t}_{\text {PLH }}$ |  | 4.5 |  | 3.9 |  | 3.6 | ns |
|  |  | $\mathrm{t}_{\text {PLH }}$ |  | 8.6 |  | 9.0 |  | 9.5 | ns |
| $t_{\text {PZL }} t_{\text {PZH }}$ $\mathrm{t}_{\mathrm{PLZ}} \mathrm{t}_{\mathrm{PHZ}}$ | Output enable and disable time | En |  | 10 |  | 10 |  | 10 | ns |
|  |  | Dis |  | 40 |  | 40 |  | 40 | ns |
| $\mathrm{D}_{\mathrm{R}}$ | Data rate ${ }^{(1)}$ |  |  | 6.4 |  | 4.5 |  | 3.0 | MHz |

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than $15 \%$ of the input $I / O$ signal period; the input I/O signal is at $50 \%$ duty cycle and the output I/O signal duty cycle deviation is not less than $30 \%$. Note that the $R_{\text {up }}$ of $4.7 \mathrm{k} \Omega$ is an effective R pull-up value. Since the device has an integrated $10 \mathrm{k} \Omega$ pull-up resistor, an effective value of $4.7 \mathrm{k} \Omega$ is obtained by adding an external $8.9 \mathrm{k} \Omega$ pull-up resistor.

Table 11. For test conditions: $\mathrm{V}_{\mathrm{L}}=2.5$ to 2.7 V (load $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} ; \mathrm{R}_{\mathrm{up}}=10 \mathrm{k} \Omega$; driver $\left.t_{r}=t_{f} \leq 2 n s\right)$ overtemperature range $-40{ }^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

| Symbol | Parameter |  | $\mathrm{V}_{\mathrm{CC}}=2.7-3.6 \mathrm{~V}$ |  | $\mathrm{V}_{\mathrm{CC}}=4.3-5.5 \mathrm{~V}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Min. | Max. |  |
| $\mathrm{t}_{\text {RVCC }}$ | Rise time I/Ovcc |  |  | 3.8 |  | 2.8 | ns |
| $\mathrm{t}_{\text {FVCC }}$ | Fall time I/OVCc |  |  | 14.8 |  | 19.1 | ns |
| $t_{\text {RVL }}$ | Rise time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}}$ |  |  | 3.3 |  | 3.2 | ns |
| $\mathrm{t}_{\mathrm{FVL}}$ | Fall time I/OVL |  |  | 9.8 |  | 10.0 | ns |
| $\mathrm{t}_{\text {/ OVL-VCC }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}} \mathrm{LH}$ $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{HL}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}-\mathrm{HL}$ | $t_{\text {PLH }}$ |  | 3.2 |  | 2.8 | ns |
|  |  | $t_{\text {PLH }}$ |  | 8.2 |  | 11.6 | ns |
| $\mathrm{t}_{\text {/ OVCC-VL }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}-\mathrm{LH}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}-\mathrm{HL}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{HL}}$ | $t_{\text {PLH }}$ |  | 2.6 |  | 2.0 | ns |
|  |  | $t_{\text {PLH }}$ |  | 5.3 |  | 5.9 | ns |
| $t_{\text {PZL }} t_{\text {PZH }}$ <br> $\mathrm{t}_{\mathrm{PLZ}} \mathrm{t}_{\mathrm{PHZ}}$ | Output enable and disable time | En |  | 6 |  | 6 | ns |
|  |  | Dis |  | 40 |  | 40 | ns |
| DR | Data rate ${ }^{(1)}$ |  |  | 9 |  | 6.8 | MHz |

[^0]Table 12. For test conditions: $\mathrm{V}_{\mathrm{L}}=2.7$ to 3.6 V (load $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} ; \mathrm{R}_{\mathrm{up}}=10 \mathrm{k} \Omega$; driver $t_{r}=t_{f} \leq 2 \mathrm{~ns}$ ) overtemperature range $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

| Symbol | Parameter |  | $\mathrm{V}_{\mathrm{CC}}$ | - 5.5 V | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. |  |
| $t_{\text {RVCC }}$ | Rise time $\mathrm{I} / \mathrm{O}_{\mathrm{Vcc}}$ |  |  | 2.9 | ns |
| $\mathrm{t}_{\text {FVCC }}$ | Fall time I/O Occ |  |  | 17.2 | ns |
| $\mathrm{t}_{\text {RVL }}$ | Rise time $1 / \mathrm{O}_{\mathrm{VL}}$ |  |  | 3.0 | ns |
| $\mathrm{t}_{\mathrm{FVL}}$ | Fall time $1 / \mathrm{O}_{\mathrm{VL}}$ |  |  | 9.7 | ns |
| $\mathrm{t}_{\text {/ OVL-vCC }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}$ LH $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{HL}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}}-\mathrm{HL}$ | $\mathrm{t}_{\text {PHL }}$ |  | 2.7 | ns |
|  |  | ${ }_{\text {t }}{ }_{\text {PHL }}$ |  | 10.6 | ns |
| $\mathrm{t}_{\text {//OVCC-VL }}$ | Propagation delay time $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}-\mathrm{LH}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{LH}}$ $\mathrm{I} / \mathrm{O}_{\mathrm{VCC}-\mathrm{HL}}$ to $\mathrm{I} / \mathrm{O}_{\mathrm{VL}-\mathrm{HL}}$ | $\mathrm{t}_{\text {PHL }}$ |  | 1.9 | ns |
|  |  | ${ }^{\text {t }}$ PHL |  | 4.8 | ns |
| $t_{\text {PZL }}$ tpzH $t_{\text {PLZ }} \mathrm{t}_{\mathrm{PHZ}}$ | Output enable and disable time | En |  | 6 | ns |
|  |  | Dis |  | 40 | ns |
| $\mathrm{D}_{\mathrm{R}}$ | Data rate ${ }^{(1)}$ |  |  | 7.2 | MHz |

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than $15 \%$ of the input I/O signal period; the input I/O signal is at $50 \%$ duty cycle and the output I/O signal duty cycle deviation is not less than $30 \%$.
Note that the $R_{\text {up }}$ of $4.7 \mathrm{k} \Omega$ is an effective $R$ pull-up value. Since the device has an integrated $10 \mathrm{k} \Omega$ pull-up resistor, an effective value of $4.7 \mathrm{k} \Omega$ is obtained by adding an external $8.9 \mathrm{k} \Omega$ pull-up resistor.

Figure 4. Test circuit


Table 13. Test circuit

| Test | Switch |  |  |
| :---: | :---: | :---: | :---: |
|  | Driving I/O VLL | Driving I/O VCC | Open drain driving |
| $\mathrm{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | Open | Open | Open |

Note: $\quad$ The pull-up resistors shown in the above test circuit are optional and are only needed if total pull-up on either end of the level translator needs to be lower than $10 \mathrm{k} \Omega$. In applications where $10 \mathrm{k} \Omega$ is sufficient, the external pull-up resistor is not required.

Table 14. Waveform symbol value

| Symbol | Driving $/ \mathrm{O}_{\mathrm{VL}}$ |  | Driving I/O VCC |  |
| :---: | :---: | :---: | :---: | :---: |
|  | $\mathbf{1 . 8} \mathrm{V} \leq \mathrm{V}_{\mathrm{L}} \leq \mathrm{V}_{\mathrm{CC}}$ <br> $\leq \mathbf{2 . 5} \mathrm{V}$ | $\mathbf{3 . 3} \mathrm{V} \leq \mathrm{V}_{\mathrm{L}} \leq \mathrm{V}_{\mathrm{CC}}$ <br> $\leq \mathbf{5 . 0} \mathrm{V}$ | $\mathbf{1 . 8} \mathrm{V} \leq \mathrm{V}_{\mathrm{L}} \leq \mathrm{V}_{\mathrm{CC}}$ <br> $\leq \mathbf{2 . 5} \mathrm{V}$ | $\mathbf{3 . 3} \mathrm{V} \leq \mathrm{V}_{\mathrm{L}} \leq \mathrm{V}_{\mathrm{CC}}$ <br> $\leq \mathbf{5 . 0} \mathrm{V}$ |
|  | $\mathrm{V}_{\mathrm{L}}$ | $\mathrm{V}_{\mathrm{L}}$ | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}$ |
| $\mathrm{V}_{\mathrm{IM}}$ | $50 \% \mathrm{~V}_{\mathrm{L}}$ | $50 \% \mathrm{~V}_{\mathrm{L}}$ | $50 \% \mathrm{~V}_{\mathrm{CC}}$ | $50 \% \mathrm{~V}_{\mathrm{CC}}$ |
| $\mathrm{V}_{\mathrm{OM}}$ | $50 \% \mathrm{~V}_{\mathrm{CC}}$ | $50 \% \mathrm{~V}_{\mathrm{CC}}$ | $50 \% \mathrm{~V}_{\mathrm{CC}}$ | $50 \% \mathrm{~V}_{\mathrm{CC}}$ |
| $\mathrm{V}_{\mathrm{X}}$ | $\mathrm{V}_{\mathrm{OL}}+15 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OL}}+0.3 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OL}}+0.15 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OL}}+0.3 \mathrm{~V}$ |
| $\mathrm{~V}_{\mathrm{Y}}$ | $\mathrm{V}_{\mathrm{OH}}-15 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OH}}-0.3 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OH}}-0.15 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OH}}-0.3 \mathrm{~V}$ |

Figure 5. Waveform - propagation delay (f =1 MHz, 50\% duty cycle)


Figure 6. Waveform - output enable/disable (f = $1 \mathrm{MHz}, 50 \%$ duty cycle)


## 3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK ${ }^{\circledR}$ packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at www.st.com. ECOPACK is an ST trademark.

Figure 7. Package outline for QFN10 ( $1.8 \times 1.4 \times 0.5 \mathrm{~mm}$ ) - 0.40 mm pitch


Table 15. Mechanical data for QFN10 ( $1.8 \times 1.4 \times 0.5 \mathrm{~mm}$ ) $\mathbf{- 0 . 4 0 \mathrm { mm } \text { pitch }}$

| Symbol | millimeters |  |  | inches |  |  | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Typ. | Min. | Max. | Typ. | Min. | Max. |  |
| A | 0.5 | 0.45 | 0.55 | 0.02 | 0.018 | 0.022 |  |
| A1 | 0.02 | 0 | 0.05 | 0.001 | 0 | 0.002 |  |
| A3 | 0.13 |  |  | 0.005 |  |  |  |
| b | 0.2 | 0.15 | 0.25 | 0.008 | 0.006 | 0.01 |  |
| D | 1.8 | 1.75 | 1.85 | 0.071 | 0.069 | 0.073 |  |
| E | 1.4 | 1.35 | 1.45 | 0.055 | 0.053 | 0.057 |  |
| e | 0.4 |  |  | 0.016 |  |  |  |
| L | 0.4 | 0.35 | 0.45 | 0.016 | 0.014 | 0.018 |  |

Figure 8. Footprint recommendation for QFN10 ( $1.8 \times 1.4 \times 0.5 \mathrm{~mm}$ ) - 0.40 mm pitch


Figure 9. Carrier tape for QFN10 ( $1.8 \times 1.4 \times 0.5 \mathrm{~mm}$ ) - 0.40 mm pitch


Figure 10. Reel information for QFN10 (1.8 $\times 1.4 \times 0.5 \mathrm{~mm})-0.40 \mathrm{~mm}$ pitch - back view


Figure 11. Reel information for QFN10 (1.8 $\times 1.4 \times 0.5 \mathrm{~mm})-0.40 \mathrm{~mm}$ pitch - front view


## 4 Revision history

Table 16. Document revision history

| Date | Revision | Changes |  |
| :---: | :---: | :--- | :--- |
| 02-Mar-2011 | 1 | Initial release. |  |

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[^0]:    1. The data rate is guaranteed based on the condition that the output $I / O$ signal rise/fall time is less than $15 \%$ of the input $I / O$ signal period; the input I/O signal is at $50 \%$ duty cycle and the output I/O signal duty cycle deviation is not less than $30 \%$. Note that the $\mathrm{R}_{\text {up }}$ of $4.7 \mathrm{k} \Omega$ is an effective R pull-up value. Since the device has an integrated $10 \mathrm{k} \Omega$ pull-up resistor, an effective value of $4.7 \mathrm{k} \Omega$ is obtained by adding an external $8.9 \mathrm{k} \Omega$ pull-up resistor.
